### INTEGRATED CIRCUITS

## DATA SHEET

### **TDA8569Q**

 $4 \times 25$  W BTL quad car radio power amplifier

Preliminary specification
File under Integrated Circuits, IC01





## $4 \times 25$ W BTL quad car radio power amplifier

### **TDA8569Q**

### **FEATURES**

- Capable of driving 2  $\Omega$  loads
- · Requires very few external components
- · High output power
- · Low output offset voltage
- Fixed gain
- Diagnostic facility (distortion, short-circuit and temperature pre-warning)
- · Good ripple rejection
- Mode select switch (operating, mute and standby)
- · Load dump protection
- Short-circuit safe to ground and to V<sub>P</sub> and across the load
- · Low power dissipation in any short-circuit condition
- · Thermally protected
- · Reverse polarity safe

- Electrostatic discharge protection
- No switch-on/switch-off plop
- Flexible leads
- · Low thermal resistance
- Pin compatible with the TDA8567Q.

### **GENERAL DESCRIPTION**

The TDA8569Q is an integrated class-B output amplifier in a 23-lead Single-In-Line (SIL) plastic power package. It contains four amplifiers in BTL configuration, each with a gain of 26 dB. The output power is  $4 \times 25$  W in a  $4 \Omega$  load.

### **APPLICATIONS**

 The device is primarily developed for car radio applications.

### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>P</sub>	operating supply voltage		6	14.4	18	V
I <sub>ORM</sub>	repetitive peak output current		_	_	7.5	Α
I <sub>q(tot)</sub>	total quiescent current		_	230	_	mA
I <sub>stb</sub>	standby current		_	0.2	100	μΑ
I <sub>sw</sub>	switch-on current		_	_	80	μΑ
$ Z_i $	input impedance		25	30	_	kΩ
Po	output power	THD = 10%	_	25	_	W
SVRR	supply voltage ripple rejection	$R_s = 0 \Omega$	_	60	_	dB
$\alpha_{cs}$	channel separation	$R_s = 10 \text{ k}\Omega$	_	50	_	dB
G <sub>v</sub>	closed loop voltage gain		25	26	27	dB
V <sub>n(o)</sub>	noise output voltage	$R_s = 0 \Omega$	_	_	120	μV
$ \Delta V_{O} $	DC output offset voltage		_	_	150	mV

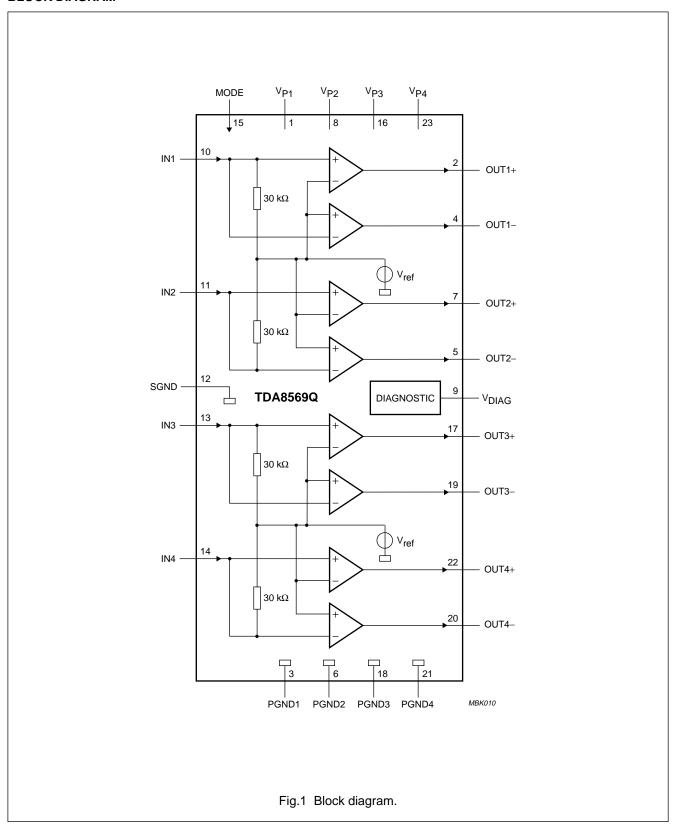
### ORDERING INFORMATION

TYPE		PACKAGE				
NUMBER	NAME	DESCRIPTION	VERSION			
TDA8569Q	DBS23P	plastic DIL-bent-SIL power package; 23 leads (straight lead length 3.2 mm)	SOT411-1			

## $4\times25~\text{W}$ BTL quad car radio power amplifier

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### **BLOCK DIAGRAM**

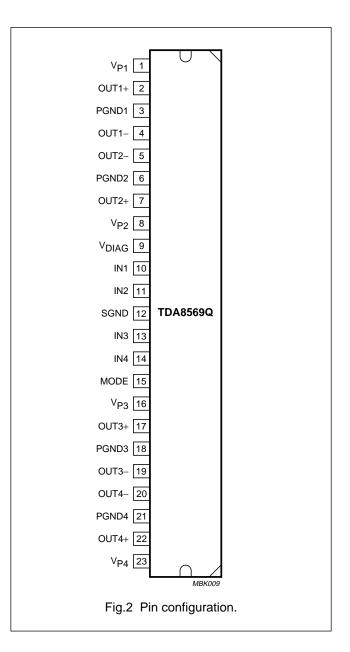


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### **PINNING**

SYMBOL	PIN	DESCRIPTION
V <sub>P1</sub>	1	supply voltage 1
OUT1+	2	output 1+
PGND1	3	power ground 1
OUT1-	4	output 1–
OUT2-	5	output 2-
PGND2	6	power ground 2
OUT2+	7	output 2+
$V_{P2}$	8	supply voltage 2
$V_{DIAG}$	9	diagnostic output
IN1	10	input 1
IN2	11	input 2
SGND	12	signal ground
IN3	13	input 3
IN4	14	input 4
MODE	15	mode select switch input
V <sub>P3</sub>	16	supply voltage 3
OUT3+	17	output 3+
PGND3	18	power ground 3
OUT3-	19	output 3-
OUT4-	20	output 4-
PGND4	21	power ground 4
OUT4+	22	output 4+
$V_{P4}$	23	supply voltage 4



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### **FUNCTIONAL DESCRIPTION**

The TDA8569Q contains four identical amplifiers which can be used for bridge applications. The gain of each amplifier is fixed at 26 dB.

### Mode select switch (pin 15)

- Standby: low supply current (<100 μA)
- · Mute: input signal suppressed
- · Operating: normal on condition.

Since this pin has a low input current ( $<80 \mu A$ ), a low cost supply switch can be applied.

To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during  $\geq$ 150 ms (charging of the input capacitors at pins 10, 11, 13 and 14).

This can be realized by:

- · Microprocessor control
- External timing circuit (see Fig.3).

### Diagnostic output (pin 9)

DYNAMIC DISTORTION DETECTOR (DDD)

At the onset of clipping of one or more output stages, the dynamic distortion detector becomes active and pin 9 goes LOW. This information can be used to drive a sound processor or DC volume control to attenuate the input signal and so limit the distortion. The output level of pin 9 is independent of the number of channels that are clipping (see Fig.4).

#### SHORT-CIRCUIT DIAGNOSTIC

When a short-circuit occurs at one or more outputs to ground or to the supply voltage, the output stages are switched off until the short-circuit is removed and the device is switched on again, with a delay of approximately 10 ms after removal of the short-circuit. During this short-circuit condition, pin 9 is continuously LOW.

When a short-circuit occurs across the load of one or more channels, the output stages are switched off during approximately 10 ms. After that time it is checked during approximately 50  $\mu s$  to determine whether the short-circuit is still present.

Due to this duty cycle of 50  $\mu s/10$  ms the average current consumption during this short-circuit condition is very low.

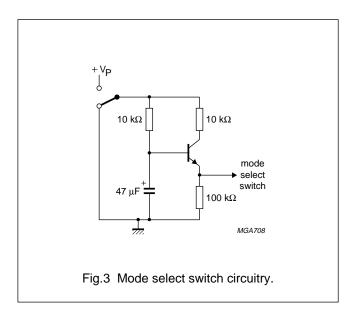
During this short-circuit condition, pin 9 is LOW for 10 ms and HIGH for 50  $\mu s$  (see Fig.5). The protection circuits of all channels are coupled. This means that if a short-circuit condition occurs in **one** of the channels, **all** channels are switched off. Consequently, the power dissipation in any short-circuit condition is very low.

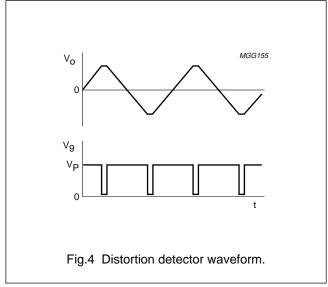
### TEMPERATURE PRE-WARNING

When the virtual junction temperature  $T_{vj}$  reaches 145 °C, pin 9 goes LOW.

### **OPEN COLLECTOR OUTPUTS**

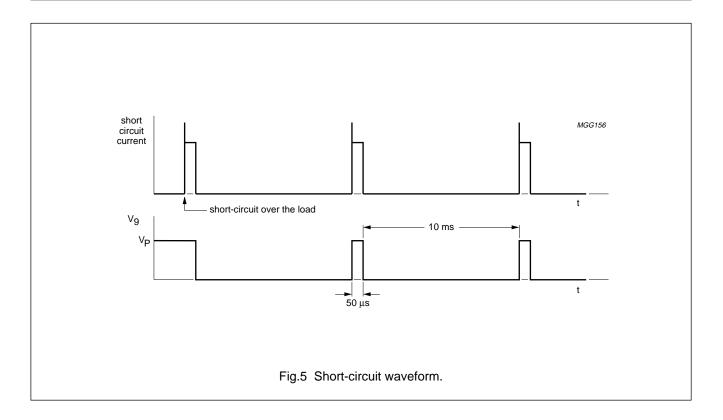
The diagnostic pin has an open collector output, so more devices can be tied together. An external pull-up resistor is needed.





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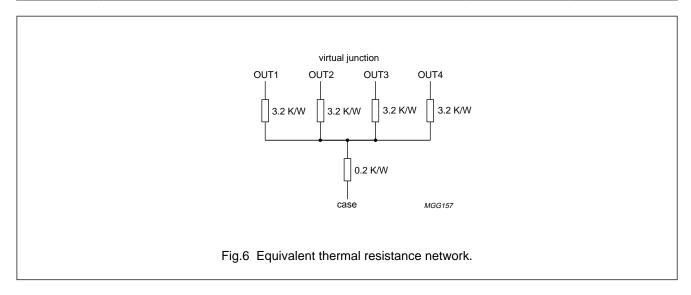
### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>P</sub>	supply voltage	operating	_	18	V
		non-operating	_	30	V
		load dump protection; during 50 ms; $t_r \ge 2.5$ ms	_	45	V
V <sub>sc(safe)</sub>	short-circuit safe voltage		_	18	V
V <sub>rp</sub>	reverse polarity voltage		_	6	V
I <sub>OSM</sub>	non-repetitive peak output current		_	10	А
I <sub>ORM</sub>	repetitive peak output current		_	7.5	Α
P <sub>tot</sub>	total power dissipation		_	60	W
T <sub>stg</sub>	storage temperature		-55	+150	°C
T <sub>amb</sub>	operating ambient temperature		-40	+85	°C
T <sub>vj</sub>	virtual junction temperature		_	150	°C

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient in free air	40	K/W
R <sub>th j-c</sub>	thermal resistance from junction to case (see Fig.6)	1	K/W



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### **DC CHARACTERISTICS**

 $V_P$  = 14.4 V;  $T_{amb}$  = 25 °C; measured in Fig.7; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply			'		1	
V <sub>P</sub>	supply voltage	note 1	6	14.4	18	V
I <sub>q(tot)</sub>	total quiescent current	R <sub>L</sub> = ∞	-	230	360	mA
Operating co	ondition					
V <sub>15</sub>	mode select switch level		8.5	_	V <sub>P</sub>	V
I <sub>15</sub>	mode select switch current	V <sub>15</sub> = 14.4 V	-	30	80	μΑ
Vo	output voltage	note 2	_	7.0	_	٧
$ \Delta V_{O} $	output offset voltage		_	_	150	mV
Mute conditie	on	•	•		•	•
V <sub>15</sub>	mode select switch level		3.3	_	6.4	V
Vo	output voltage	note 2	_	7.0	_	٧
$ \Delta V_{O} $	output offset voltage		_	_	150	mV
Standby con	dition	·			•	•
V <sub>15</sub>	mode select switch level		0	_	2	V
I <sub>stb</sub>	standby current		-	0.2	100	μΑ
Diagnostic						
V <sub>9</sub>	diagnostic output voltage	during any fault condition	-	_	0.6	V
T <sub>vj</sub>	temperature pre-warning	V <sub>9</sub> = 0.6 V	_	145	_	°C

### Notes

- 1. The circuit is DC adjusted at  $V_P$  = 6 to 18 V and AC operating at  $V_P$  = 8.5 to 18 V.
- 2. At 18 V <  $V_P$  < 30 V the DC output voltage  $\leq 1\!/_{\!2}V_P.$

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### **AC CHARACTERISTICS**

 $V_P$  = 14.4 V;  $R_L$  = 4  $\Omega$ ; f = 1 kHz;  $T_{amb}$  = 25 °C; measured in Fig.7; unless otherwise specified.

PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
output power	THD = 0.5%	16	19	_	W
	THD = 10%	21	25	_	W
	THD = 30%	28	35	_	W
	V <sub>P</sub> = 13.2 V; THD = 0.5%	_	15	_	W
	V <sub>P</sub> = 13.2 V; THD = 10%	_	21	_	W
total harmonic distortion	P <sub>o</sub> = 1 W	_	0.05	_	%
	V <sub>9</sub> ≤ 0.6 V; note 8	_	10	_	%
power bandwidth	THD = 0.5%; $P_0 = -1 \text{ dB}$ with respect to 16 W	_	20 to 20000	_	Hz
low frequency roll-off	at -1 dB; note 1	_	25	_	Hz
high frequency roll-off	at -1 dB	20	_	_	kHz
closed loop voltage gain		25	26	27	dB
supply voltage ripple rejection	on; note 2	50	_	_	dB
	mute; note 2	50	_	_	dB
	standby; note 2	80	_	_	dB
input impedance		25	30	38	kΩ
noise output voltage	on; note 3	_	85	120	μV
	on; note 4	_	100	_	μV
	mute; note 5	_	60	_	μV
channel separation	note 6	45	_	_	dB
channel unbalance		_	_	1	dB
output signal in mute	note 7	_	_	2	mV
output power	THD = 0.5%; $R_L = 2 \Omega$	_	30	_	W
	THD = 10%; $R_L = 2 \Omega$	_	40	_	W
	THD = 30%; $R_L = 2 \Omega$	_	55	_	W
total harmonic distortion	$P_0 = 1 \text{ W}; R_L = 2 \Omega$	-	0.1	_	%
	total harmonic distortion  power bandwidth  low frequency roll-off high frequency roll-off closed loop voltage gain supply voltage ripple rejection  input impedance noise output voltage  channel separation channel unbalance output signal in mute output power	$ \begin{array}{c} \text{output power} \\ \hline \\ & THD = 10\% \\ \hline \\ & THD = 30\% \\ \hline \\ & V_P = 13.2 \text{ V}; \text{ THD} = 0.5\% \\ \hline \\ & V_P = 13.2 \text{ V}; \text{ THD} = 10\% \\ \hline \\ & V_P = 13.2 \text{ V}; \text{ THD} = 10\% \\ \hline \\ & V_9 \leq 0.6 \text{ V}; \text{ note } 8 \\ \hline \\ & power bandwidth \\ \hline \\ & IDMAR \\ \hline \\ & IDMAR \\ \hline \\ & IDMAR & $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

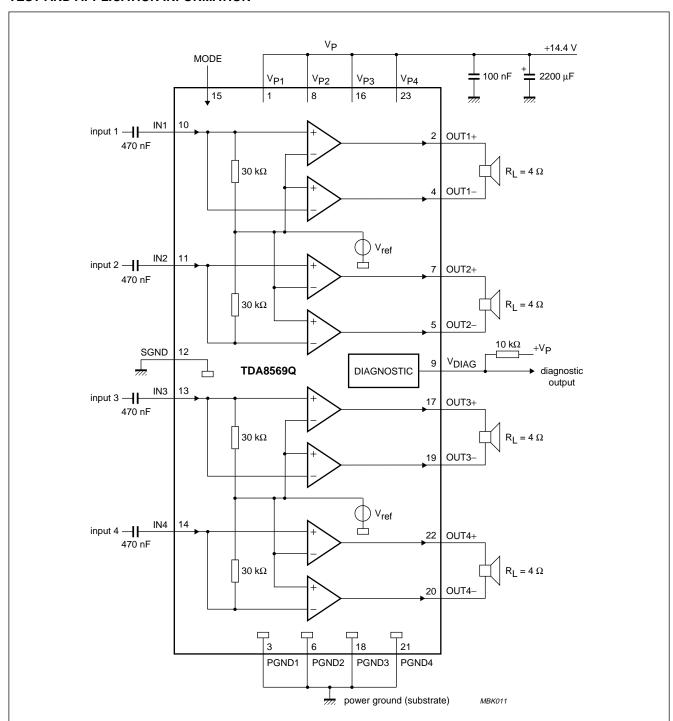
### Notes

- 1. Frequency response externally fixed.
- 2.  $V_{ripple} = V_{ripple(max)} = 2 V (p-p); R_s = 0 \Omega.$
- 3. B = 20 Hz to 20 kHz;  $R_s = 0 \Omega$ .
- 4.  $B = 20 \text{ Hz to } 20 \text{ kHz}; R_s = 10 \text{ k}\Omega.$
- 5. B = 20 Hz to 20 kHz; independent of  $R_s$ .
- 6.  $P_O = 16 \text{ W}$ ;  $R_s = 10 \text{ k}\Omega$ .
- 7.  $V_i = V_{i(max)} = 1 \text{ V (RMS)}.$
- 8. Dynamic Distortion Detector (DDD) active, pin 9 is set to logic 0.

## $4 \times 25 \text{ W BTL}$ quad car radio power amplifier

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### **TEST AND APPLICATION INFORMATION**



Special care must be taken in the PCB-layout to separate pin 9 from the pins 10, 11 13 and 14 to minimize the crosstalk between the clip output and the inputs.

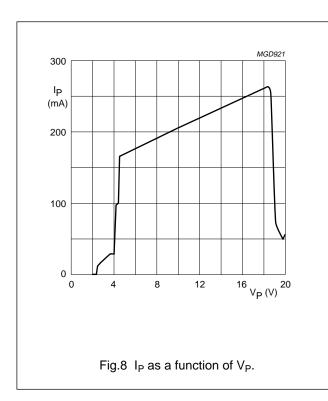
To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during a period of ≥150 ms (charging the input capacitors at pin 10, 11, 13 and 14).

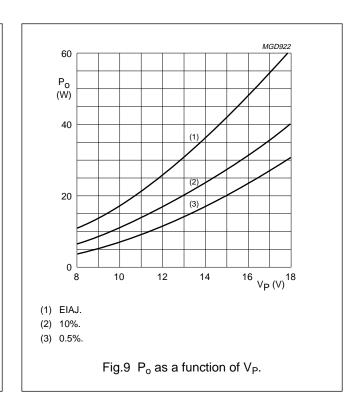
Fig.7 Application circuit diagram.

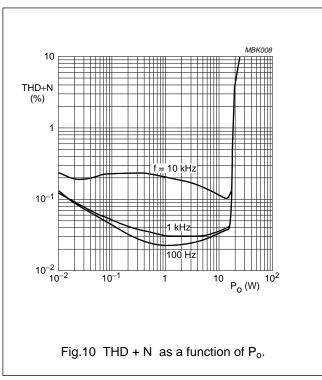
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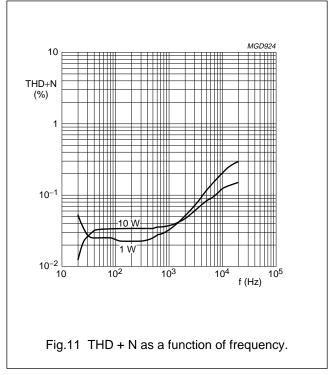
### **Test information**

Figures 8 to 13 have the following conditions:  $V_P = 14.4 \text{ V}$ ;  $R_L = 4 \Omega$ ; f = 1 kHz; 80 kHz filter used; unless otherwise specified.



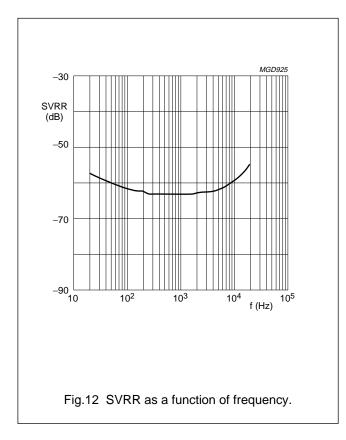






## $4\times25~\text{W}$ BTL quad car radio power amplifier

### TDA8569Q



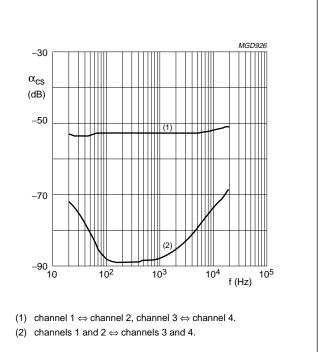
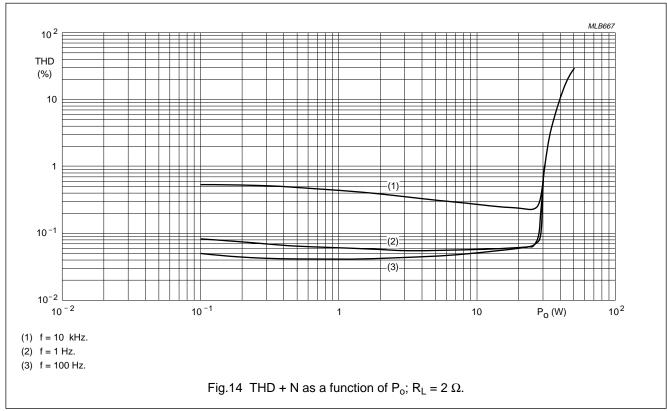
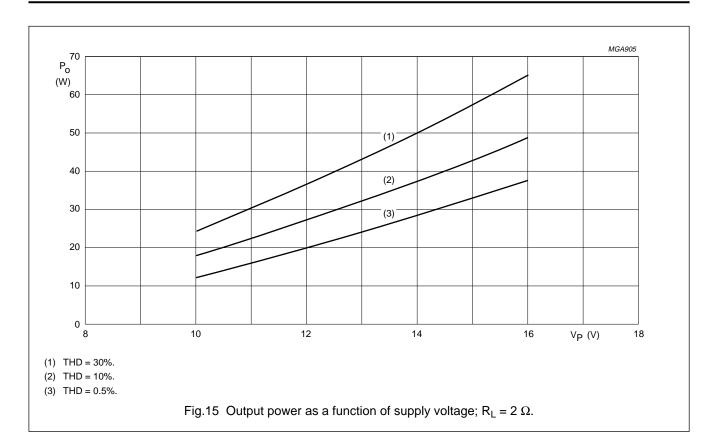


Fig.13 Channel separation as a function of frequency.



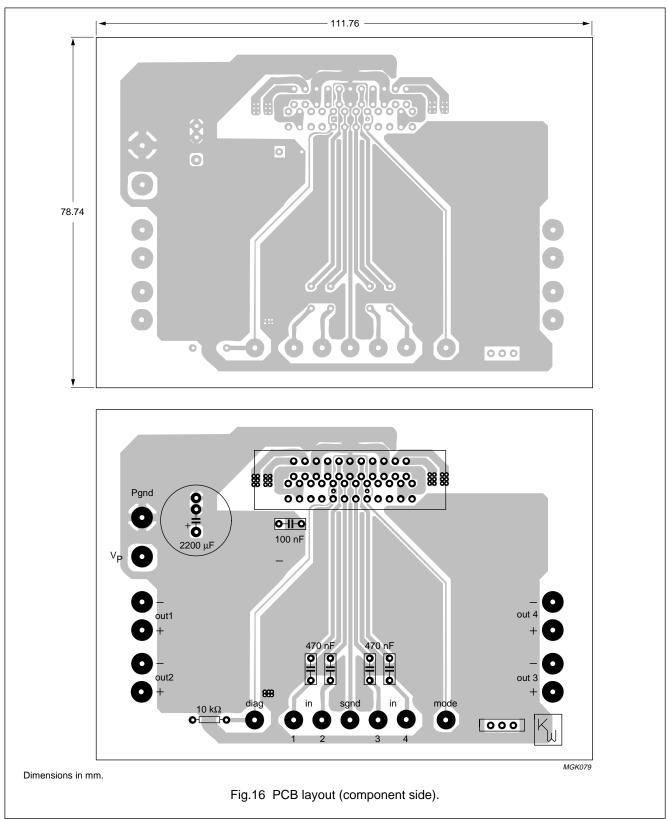
# $4\times25~\text{W}$ BTL quad car radio power amplifier

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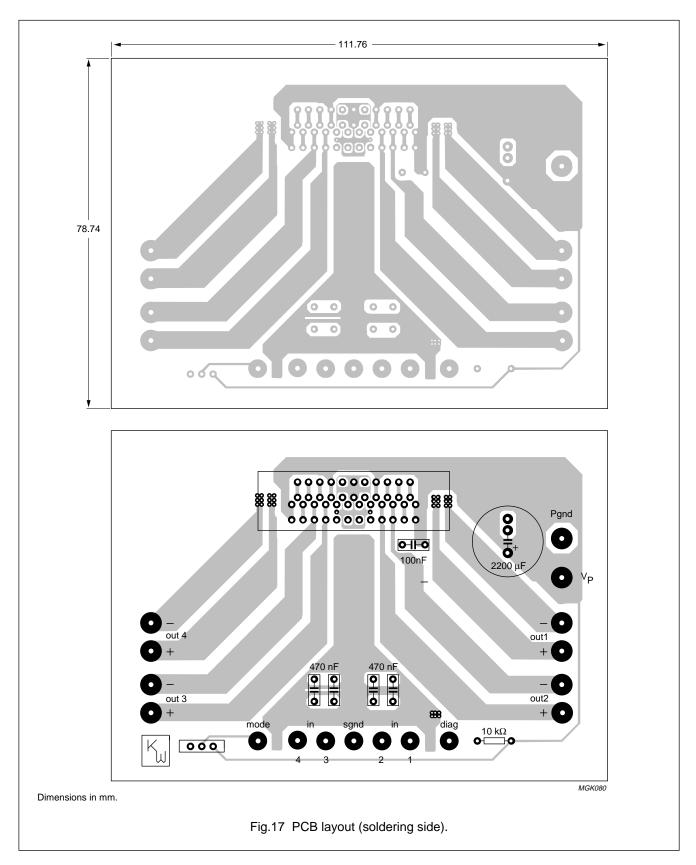


TDA8569Q

### **PCB** layout



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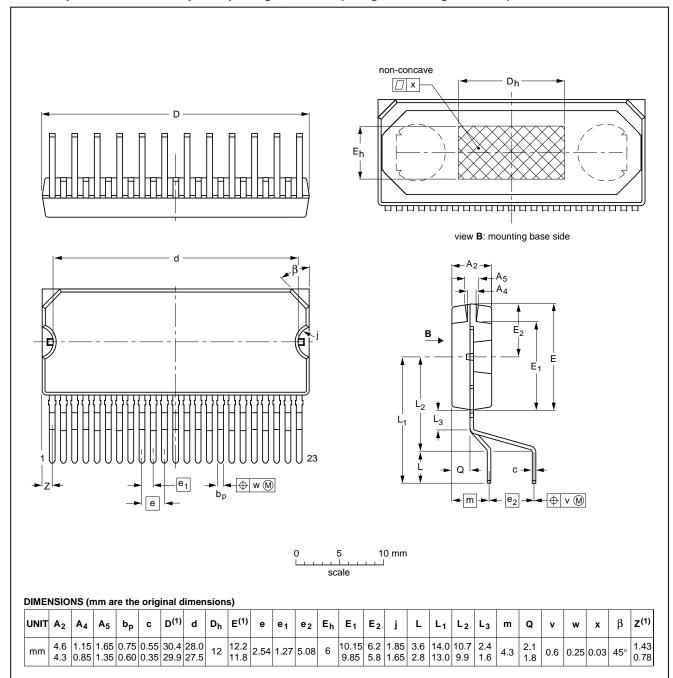


TDA8569Q

### **PACKAGE OUTLINE**

DBS23P: plastic DIL-bent-SIL power package; 23 leads (straight lead length 3.2 mm)

SOT411-1



### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN ISSUE D	
VERSION	IEC	IEC JEDEC EIAJ		PROJECTION	ISSUE DATE
SOT411-1					96-10-11

### $4 \times 25$ W BTL quad car radio power amplifier

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### **SOLDERING**

### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

### Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg\ max}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

### Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300  $^{\circ}$ C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400  $^{\circ}$ C, contact may be up to 5 seconds.

### **DEFINITIONS**

Data sheet status

Data Sileet Status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information					
Where application information is given, it is advisory and does not form part of the specification.					

### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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**NOTES** 

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**NOTES** 

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